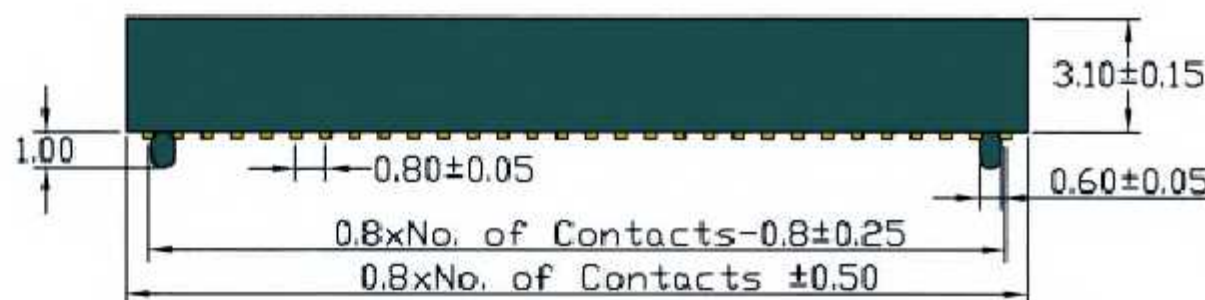
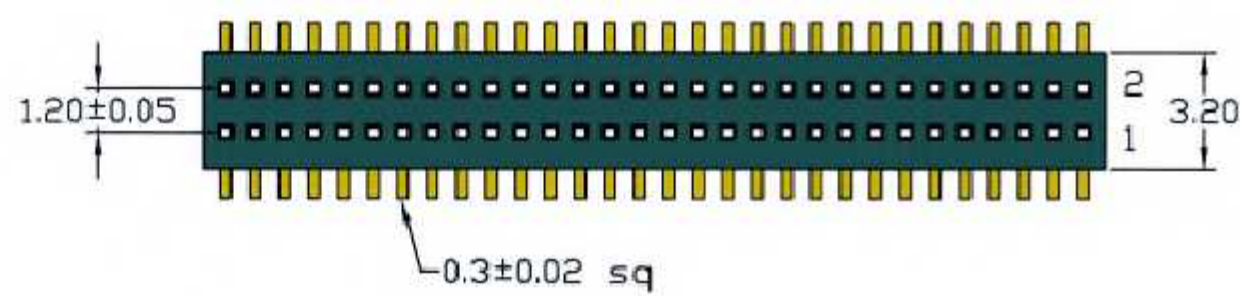
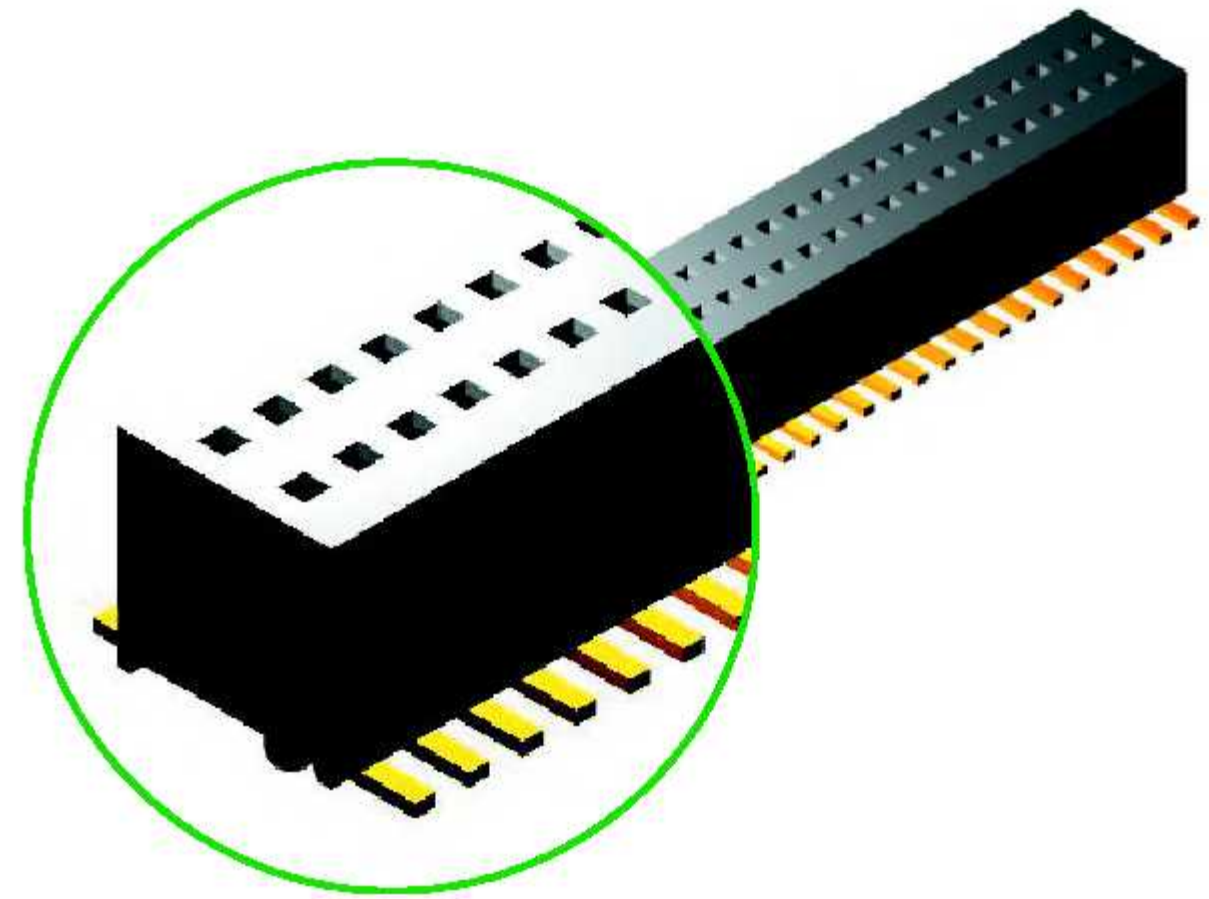
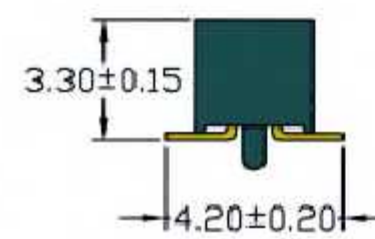
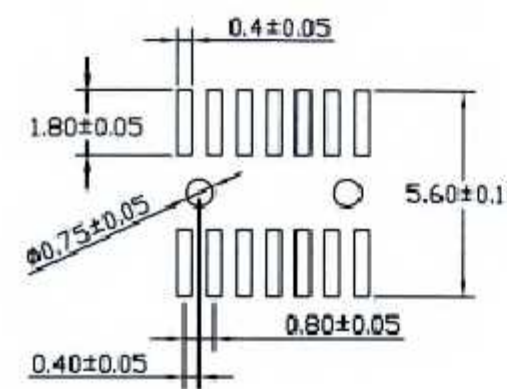


Female Header SMT



Recommended P.C.Board SMD Layout



SPECIFICATIONS

SPECIFICATIONS

- Current Rating: 1 Amp
- Insulator Resistance: 1000 Megohms Min.
- Contact Resistance: 20 m ohms Max.
- Dielectric Withstanding: AC 500V/minute
- Operating Temperature: -40° ~ +105°C
- Contact Material: Phosphor bronze
- Insulator Material: LCP UL94V-0
- Color: Black
- Finish: Gold, Tin or Duplex plated
- Standard: Gold flash
- Duplex plated: Gold plated on contact area
Tin on solder area

P 8 8 3 2 - X X M X X - X X X

Female Header

Number of contacts

Locating peg

- 10** w/o Locating peg
- OP** with Locating peg

Plating thickness

- 01** Normal
- 03** 3 μ
- 05** 5 μ
- 10** 10 μ
- 15** 15 μ
- 30** 30 μ

Plating material

- G** Gold plated
- T** Tin plated
- P** Lead & Tin plated
- H** Selective gold plated